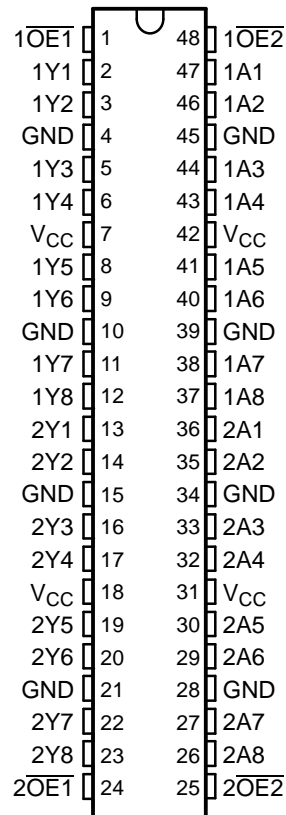


## FEATURES

- Member of the Texas Instruments Widebus™ Family
- Operates From 1.65 V to 3.6 V
- Inputs Accept Voltages to 5.5 V
- Max  $t_{pd}$  of 4.2 ns at 3.3 V
- Typical  $V_{OLP}$  (Output Ground Bounce) <0.8 V at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$
- Typical  $V_{OHV}$  (Output  $V_{OH}$  Undershoot) >2 V at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$
- $I_{off}$  Supports Partial-Power-Down Mode Operation
- Supports Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V  $V_{CC}$ )
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 1000-V Charged-Device Model (C101)

DGG, DGV, OR DL PACKAGE  
(TOP VIEW)



## DESCRIPTION/ORDERING INFORMATION

This 16-bit buffer/driver is designed for 1.65-V to 3.6-V  $V_{CC}$  operation.

The SN74LVCH16541A is a noninverting 16-bit buffer composed of two 8-bit sections with separate output-enable signals. For either 8-bit buffer section, the two output-enable ( $1\overline{OE}1$  and  $1\overline{OE}2$  or  $2\overline{OE}1$  and  $2\overline{OE}2$ ) inputs must be low for the corresponding Y outputs to be active. If either output-enable input is high, the outputs of that 8-bit buffer section are in the high-impedance state.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

## ORDERING INFORMATION

| $T_A$         | PACKAGE <sup>(1)</sup> |               | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|---------------|------------------------|---------------|-----------------------|------------------|
| –40°C to 85°C | SSOP – DL              | Tube          | SN74LVCH16541ADL      | LVCH16541A       |
|               |                        | Tape and reel | SN74LVCH16541ADLR     |                  |
|               | TSSOP – DGG            | Tape and reel | SN74LVCH16541ADGGR    | LVCH16541A       |
|               | TVSOP – DGV            | Tape and reel | SN74LVCH16541ADGVR    | LDH541A          |

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Widebus is a trademark of Texas Instruments.

**SN74LVCH16541A**  
**16-BIT BUFFER/DRIVER**  
**WITH 3-STATE OUTPUTS**

SCAS567H—MARCH 1996—REVISED MARCH 2005

**DESCRIPTION/ORDERING INFORMATION (CONTINUED)**

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.

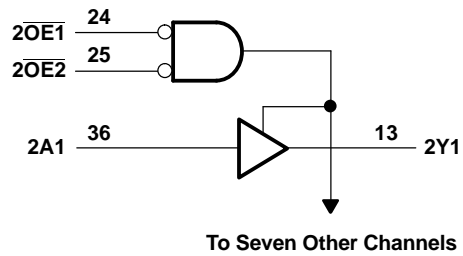
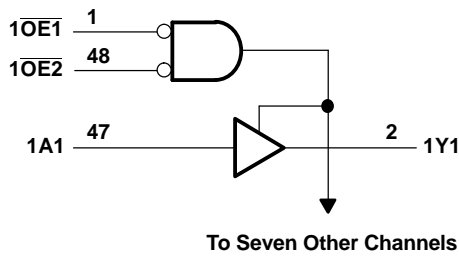
Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

**FUNCTION TABLE**  
**(EACH 8-BIT SECTION)**

| INPUTS           |                  |   | OUTPUT<br>Y |
|------------------|------------------|---|-------------|
| $\overline{OE1}$ | $\overline{OE2}$ | A |             |
| L                | L                | L | L           |
| L                | L                | H | H           |
| H                | X                | X | Z           |
| X                | H                | X | Z           |

**LOGIC DIAGRAM (POSITIVE LOGIC)**



### Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                  |   | MIN                | MAX                   | UNIT    |
|------------------|---|--------------------|-----------------------|---------|
| V <sub>CC</sub>  | Supply voltage range  | –0.5               | 6.5                   | V       |
| V <sub>I</sub>   | Input voltage range <sup>(2)</sup>  | –0.5               | 6.5                   | V       |
| V <sub>O</sub>   | Voltage range applied to any output in the high-impedance or power-off state <sup>(2)</sup> | –0.5               | 6.5                   | V       |
| V <sub>O</sub>   | Voltage range applied to any output in the high or low state <sup>(2)(3)</sup>              | –0.5               | V <sub>CC</sub> + 0.5 | V       |
| I <sub>IK</sub>  | Input clamp current   | V <sub>I</sub> < 0 |                       | –50 mA  |
| I <sub>OK</sub>  | Output clamp current  | V <sub>O</sub> < 0 |                       | –50 mA  |
| I <sub>O</sub>   | Continuous output current   |                    |                       | ±50 mA  |
|                  | Continuous current through V <sub>CC</sub> or GND   |                    |                       | ±100 mA |
| θ <sub>JA</sub>  | Package thermal impedance <sup>(4)</sup>  | DGG package        |                       | 70 °C/W |
|                  |   | DGV package        |                       | 58 °C/W |
|                  |   | DL package         |                       | 63 °C/W |
| T <sub>stg</sub> | Storage temperature range   | –65                | 150                   | °C      |

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The value of V<sub>CC</sub> is provided in the recommended operating conditions table.
- (4) The package thermal impedance is calculated in accordance with JESD 51-7.

### Recommended Operating Conditions<sup>(1)</sup>

|                 |                                    | MIN                                | MAX                    | UNIT            |    |
|-----------------|------------------------------------|------------------------------------|------------------------|-----------------|----|
| V <sub>CC</sub> | Supply voltage                     | Operating                          | 1.65                   | 3.6             | V  |
|                 |                                    | Data retention only                | 1.5                    |                 |    |
| V <sub>IH</sub> | High-level input voltage           | V <sub>CC</sub> = 1.65 V to 1.95 V | 0.65 × V <sub>CC</sub> |                 | V  |
|                 |                                    | V <sub>CC</sub> = 2.3 V to 2.7 V   | 1.7                    |                 |    |
|                 |                                    | V <sub>CC</sub> = 2.7 V to 3.6 V   | 2                      |                 |    |
| V <sub>IL</sub> | Low-level input voltage            | V <sub>CC</sub> = 1.65 V to 1.95 V | 0.35 × V <sub>CC</sub> |                 | V  |
|                 |                                    | V <sub>CC</sub> = 2.3 V to 2.7 V   | 0.7                    |                 |    |
|                 |                                    | V <sub>CC</sub> = 2.7 V to 3.6 V   | 0.8                    |                 |    |
| V <sub>I</sub>  | Input voltage                      | 0                                  | 5.5                    | V               |    |
| V <sub>O</sub>  | Output voltage                     | High or low state                  | 0                      | V <sub>CC</sub> | V  |
|                 |                                    | 3-state                            | 0                      | 5.5             |    |
| I <sub>OH</sub> | High-level output current          | V <sub>CC</sub> = 1.65 V           | –4                     |                 | mA |
|                 |                                    | V <sub>CC</sub> = 2.3 V            | –8                     |                 |    |
|                 |                                    | V <sub>CC</sub> = 2.7 V            | –12                    |                 |    |
|                 |                                    | V <sub>CC</sub> = 3 V              | –24                    |                 |    |
| I <sub>OL</sub> | Low-level output current           | V <sub>CC</sub> = 1.65 V           | 4                      |                 | mA |
|                 |                                    | V <sub>CC</sub> = 2.3 V            | 8                      |                 |    |
|                 |                                    | V <sub>CC</sub> = 2.7 V            | 12                     |                 |    |
|                 |                                    | V <sub>CC</sub> = 3 V              | 24                     |                 |    |
| Δt/Δv           | Input transition rise or fall rate |                                    | 10                     | ns/V            |    |
| T <sub>A</sub>  | Operating free-air temperature     | –40                                | 85                     | °C              |    |

- (1) All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

# SN74LVCH16541A

## 16-BIT BUFFER/DRIVER

### WITH 3-STATE OUTPUTS

SCAS567H—MARCH 1996—REVISED MARCH 2005

### Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER                | TEST CONDITIONS  | V <sub>CC</sub> | MIN                   | TYP <sup>(1)</sup> | MAX  | UNIT |    |
|--------------------------|--|-----------------|-----------------------|--------------------|------|------|----|
| V <sub>OH</sub>          | I <sub>OH</sub> = -100 μA  | 1.65 V to 3.6 V | V <sub>CC</sub> - 0.2 |                    |      | V    |    |
|                          | I <sub>OH</sub> = -4 mA  | 1.65 V          | 1.2                   |                    |      |      |    |
|                          | I <sub>OH</sub> = -8 mA  | 2.3 V           | 1.7                   |                    |      |      |    |
|                          | I <sub>OH</sub> = -12 mA   | 2.7 V           | 2.2                   |                    |      |      |    |
|                          |  | 3 V             | 2.4                   |                    |      |      |    |
| I <sub>OH</sub> = -24 mA | 3 V  | 2.2             |                       |                    |      |      |    |
| V <sub>OL</sub>          | I <sub>OL</sub> = 100 μA   | 1.65 V to 3.6 V |                       |                    | 0.2  | V    |    |
|                          | I <sub>OL</sub> = 4 mA   | 1.65 V          |                       |                    | 0.45 |      |    |
|                          | I <sub>OL</sub> = 8 mA   | 2.3 V           |                       |                    | 0.7  |      |    |
|                          | I <sub>OL</sub> = 12 mA  | 2.7 V           |                       |                    | 0.4  |      |    |
|                          | I <sub>OL</sub> = 24 mA  | 3 V             |                       |                    | 0.55 |      |    |
| I <sub>I</sub>           | V <sub>I</sub> = 0 to 5.5 V  | 3.6 V           |                       |                    | ±5   | μA   |    |
| I <sub>I(hold)</sub>     | V <sub>I</sub> = 0.58 V <sup>(2)</sup>                                       | 1.65 V          |                       |                    | (2)  | μA   |    |
|                          | V <sub>I</sub> = 1.07 V  |                 |                       |                    | (2)  |      |    |
|                          | V <sub>I</sub> = 0.7 V   | 2.3 V           |                       |                    | 45   |      |    |
|                          | V <sub>I</sub> = 1.7 V   |                 |                       |                    | -45  |      |    |
|                          | V <sub>I</sub> = 0.8 V   | 3 V             |                       |                    | 75   |      |    |
|                          | V <sub>I</sub> = 2 V   |                 |                       |                    | -75  |      |    |
|                          | V <sub>I</sub> = 0 to 3.6 V <sup>(3)</sup>                                   | 3.6 V           |                       |                    | ±500 |      |    |
| I <sub>off</sub>         | V <sub>I</sub> or V <sub>O</sub> = 5.5 V                                     | 0               |                       |                    | ±10  | μA   |    |
| I <sub>OZ</sub>          | V <sub>O</sub> = 0 to 5.5 V  | 3.6 V           |                       |                    | ±10  | μA   |    |
| I <sub>CC</sub>          | V <sub>I</sub> = V <sub>CC</sub> or GND                                      | 3.6 V           | I <sub>O</sub> = 0    |                    |      | 20   | μA |
|                          | 3.6 V ≤ V <sub>I</sub> ≤ 5.5 V <sup>(4)</sup>                                |                 |                       |                    |      | 20   |    |
| ΔI <sub>CC</sub>         | One input at V <sub>CC</sub> - 0.6 V, Other inputs at V <sub>CC</sub> or GND | 2.7 V to 3.6 V  |                       |                    | 500  | μA   |    |
| C <sub>i</sub>           | V <sub>I</sub> = V <sub>CC</sub> or GND                                      | 3.3 V           |                       |                    | 5    | pF   |    |
| C <sub>o</sub>           | V <sub>O</sub> = V <sub>CC</sub> or GND                                      | 3.3 V           |                       |                    | 6.5  | pF   |    |

(1) All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.

(2) This information was not available at the time of publication.

(3) This is the bus-hold maximum dynamic current required to switch the input from one state to another.

(4) This applies in the disabled state only.

### Switching Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM (INPUT)    | TO (OUTPUT) | V <sub>CC</sub> = 1.8 V ± 0.15 V |     | V <sub>CC</sub> = 2.5 V ± 0.2 V |     | V <sub>CC</sub> = 2.7 V |     | V <sub>CC</sub> = 3.3 V ± 0.3 V |     | UNIT |
|------------------|-----------------|-------------|----------------------------------|-----|---------------------------------|-----|-------------------------|-----|---------------------------------|-----|------|
|                  |                 |             | MIN                              | MAX | MIN                             | MAX | MIN                     | MAX | MIN                             | MAX |      |
| t <sub>pd</sub>  | A               | Y           | (1)                              | (1) | (1)                             | (1) | 5                       |     | 1.1                             | 4.2 | ns   |
| t <sub>en</sub>  | $\overline{OE}$ | Y           | (1)                              | (1) | (1)                             | (1) | 6.9                     |     | 1.5                             | 5.6 | ns   |
| t <sub>dis</sub> | $\overline{OE}$ | Y           | (1)                              | (1) | (1)                             | (1) | 7.4                     |     | 1.9                             | 6.8 | ns   |

(1) This information was not available at the time of publication.

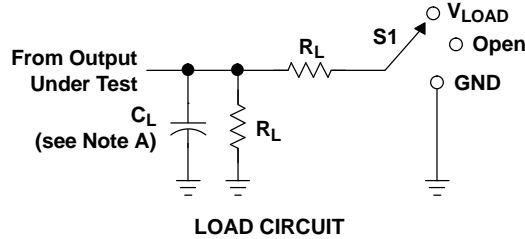
## Operating Characteristics

$T_A = 25^\circ\text{C}$

| PARAMETER |   | TEST CONDITIONS  | $V_{CC} = 1.8\text{ V}$ | $V_{CC} = 2.5\text{ V}$ | $V_{CC} = 3.3\text{ V}$ | UNIT |
|-----------|---|------------------|-------------------------|-------------------------|-------------------------|------|
|           |   |                  | TYP                     | TYP                     | TYP                     |      |
| $C_{pd}$  | Power dissipation capacitance per buffer/driver | Outputs enabled  | (1)                     | (1)                     | 35                      | pF   |
|           |   | Outputs disabled | (1)                     | (1)                     | 4                       |      |

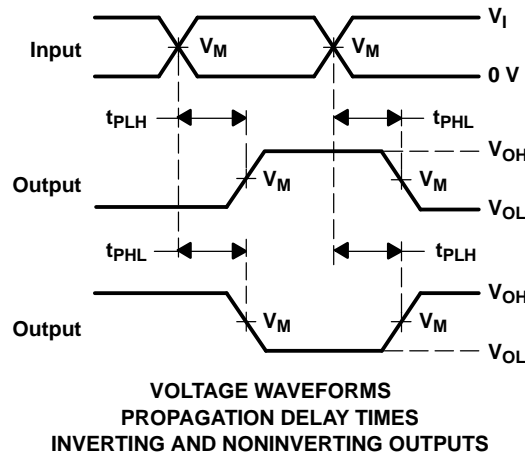
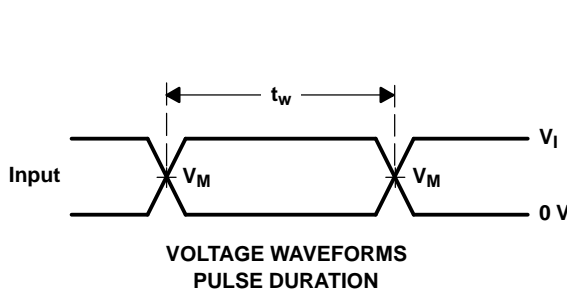
(1) This information was not available at the time of publication.

PARAMETER MEASUREMENT INFORMATION



| TEST              | S1         |
|-------------------|------------|
| $t_{PLH}/t_{PHL}$ | Open       |
| $t_{PLZ}/t_{PZL}$ | $V_{LOAD}$ |
| $t_{PHZ}/t_{PZH}$ | GND        |

| $V_{CC}$                         | INPUTS   |                      | $V_M$      | $V_{LOAD}$        | $C_L$ | $R_L$        | $V_{\Delta}$ |
|----------------------------------|----------|----------------------|------------|-------------------|-------|--------------|--------------|
|                                  | $V_I$    | $t_r/t_f$            |            |                   |       |              |              |
| $1.8\text{ V} \pm 0.15\text{ V}$ | $V_{CC}$ | $\leq 2\text{ ns}$   | $V_{CC}/2$ | $2 \times V_{CC}$ | 30 pF | 1 k $\Omega$ | 0.15 V       |
| $2.5\text{ V} \pm 0.2\text{ V}$  | $V_{CC}$ | $\leq 2\text{ ns}$   | $V_{CC}/2$ | $2 \times V_{CC}$ | 30 pF | 500 $\Omega$ | 0.15 V       |
| 2.7 V                            | 2.7 V    | $\leq 2.5\text{ ns}$ | 1.5 V      | 6 V               | 50 pF | 500 $\Omega$ | 0.3 V        |
| $3.3\text{ V} \pm 0.3\text{ V}$  | 2.7 V    | $\leq 2.5\text{ ns}$ | 1.5 V      | 6 V               | 50 pF | 500 $\Omega$ | 0.3 V        |



- NOTES:
- A.  $C_L$  includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ .
  - D. The outputs are measured one at a time, with one transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
  - H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

**PACKAGING INFORMATION**

| Orderable Device   | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|--------------------|---------------|--------------|-----------------|------|-------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| SN74LVCH16541ADGGR | ACTIVE        | TSSOP        | DGG             | 48   | 2000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | LVCH16541A              | <a href="#">Samples</a> |
| SN74LVCH16541ADGVR | ACTIVE        | TVSOP        | DGV             | 48   | 2000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | LDH541A                 | <a href="#">Samples</a> |
| SN74LVCH16541ADL   | ACTIVE        | SSOP         | DL              | 48   | 25          | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | LVCH16541A              | <a href="#">Samples</a> |
| SN74LVCH16541ADLG4 | ACTIVE        | SSOP         | DL              | 48   | 25          | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | LVCH16541A              | <a href="#">Samples</a> |
| SN74LVCH16541ADLR  | ACTIVE        | SSOP         | DL              | 48   | 1000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | LVCH16541A              | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

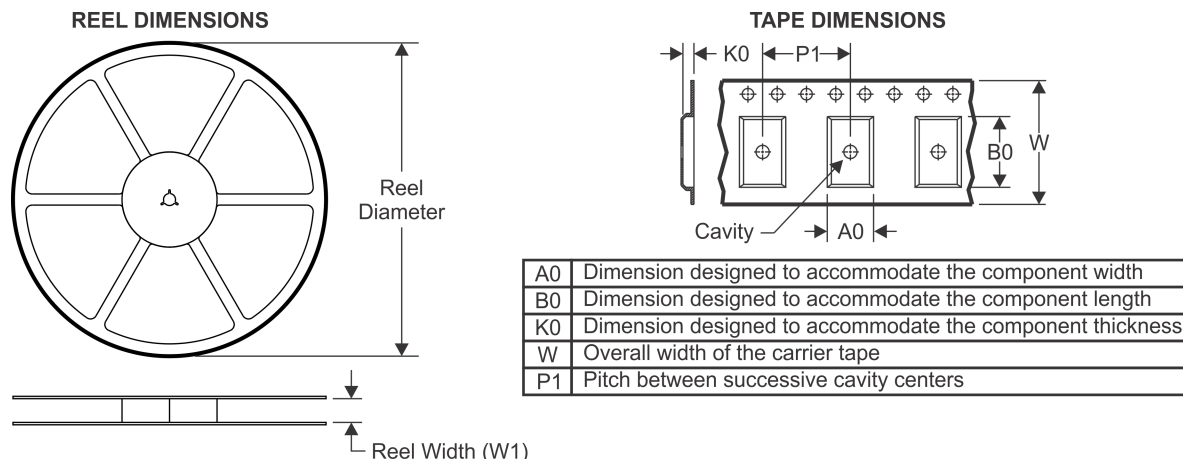
(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## TAPE AND REEL INFORMATION



### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



\*All dimensions are nominal

| Device             | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74LVCH16541ADGGR | TSSOP        | DGG             | 48   | 2000 | 330.0              | 24.4               | 8.6     | 13.0    | 1.8     | 12.0    | 24.0   | Q1            |
| SN74LVCH16541ADGVR | TVSOP        | DGV             | 48   | 2000 | 330.0              | 16.4               | 7.1     | 10.2    | 1.6     | 12.0    | 16.0   | Q1            |
| SN74LVCH16541ADLR  | SSOP         | DL              | 48   | 1000 | 330.0              | 32.4               | 11.35   | 16.2    | 3.1     | 16.0    | 32.0   | Q1            |

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

| Device             | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LVCH16541ADGGR | TSSOP        | DGG             | 48   | 2000 | 367.0       | 367.0      | 45.0        |
| SN74LVCH16541ADGVR | TVSOP        | DGV             | 48   | 2000 | 853.0       | 449.0      | 35.0        |
| SN74LVCH16541ADLR  | SSOP         | DL              | 48   | 1000 | 367.0       | 367.0      | 55.0        |

**TUBE**


\*All dimensions are nominal

| Device             | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|--------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74LVCH16541ADL   | DL           | SSOP         | 48   | 25  | 473.7  | 14.24  | 5110   | 7.87   |
| SN74LVCH16541ADLG4 | DL           | SSOP         | 48   | 25  | 473.7  | 14.24  | 5110   | 7.87   |

# MECHANICAL DATA

DL (R-PDSO-G48)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - Falls within JEDEC MO-118

PowerPAD is a trademark of Texas Instruments.

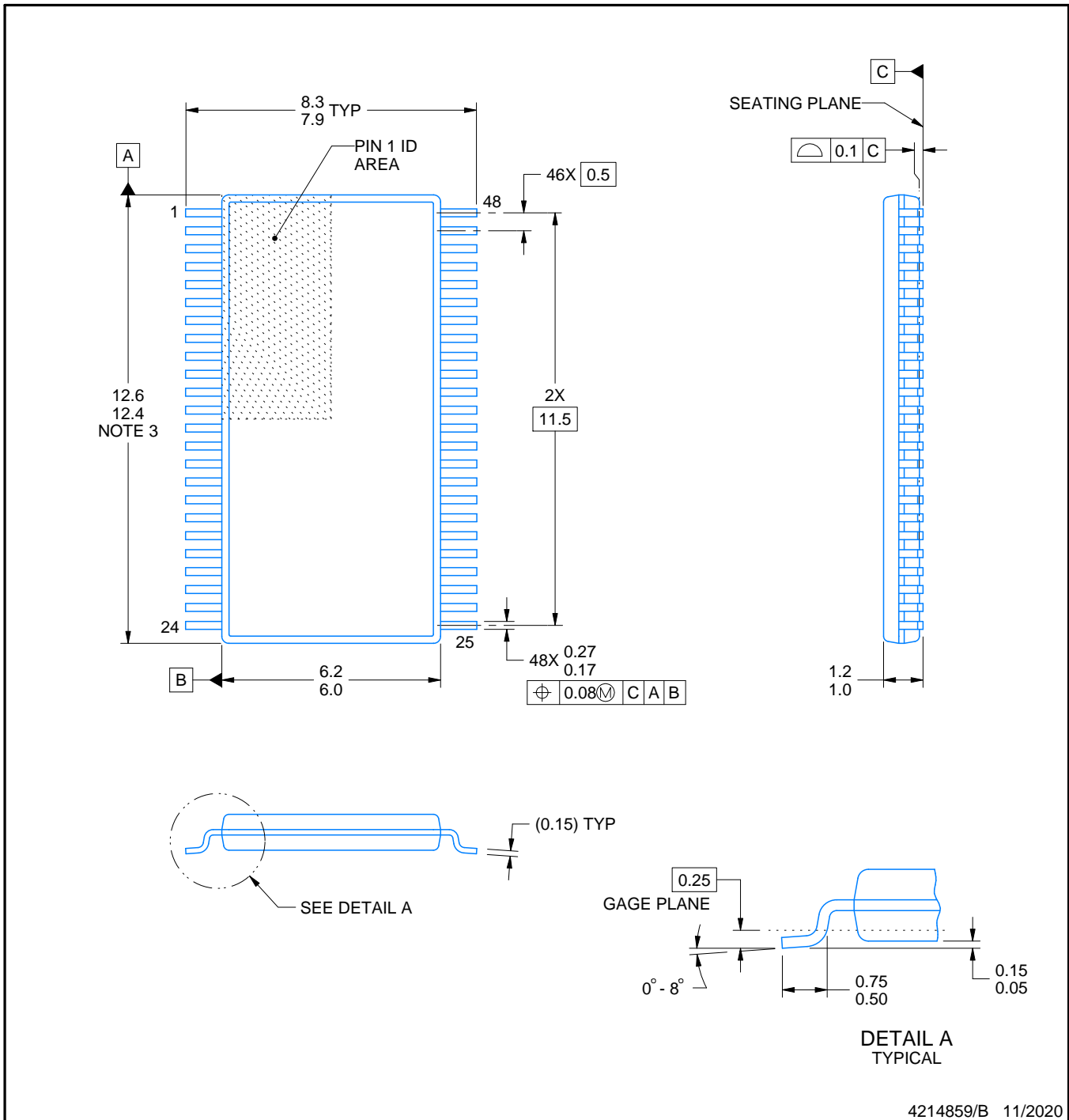
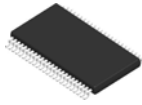
DGV (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE

24 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.  
 D. Falls within JEDEC: 24/48 Pins – MO-153  
 14/16/20/56 Pins – MO-194



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NOTES:

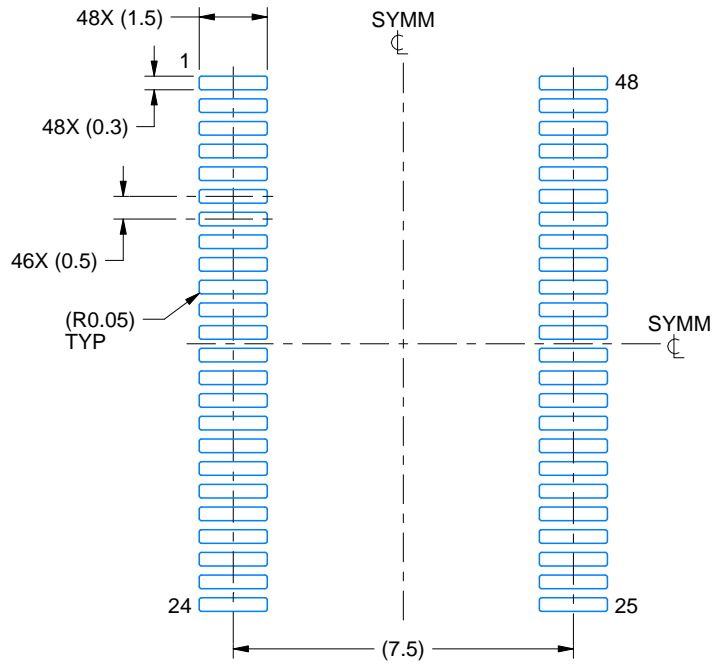
- All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- This drawing is subject to change without notice.
- This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
- Reference JEDEC registration MO-153.

# EXAMPLE BOARD LAYOUT

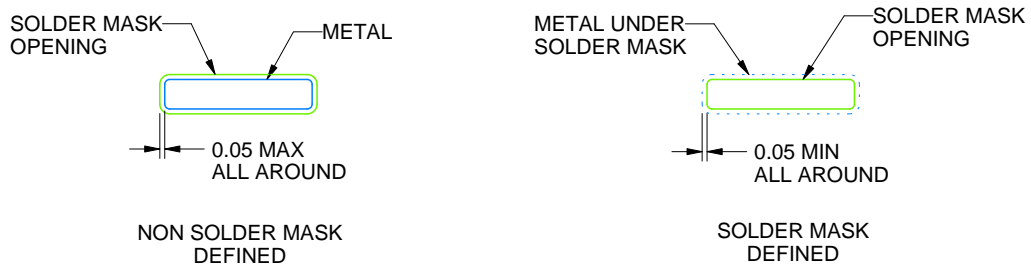
DGG0048A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
SCALE:6X



SOLDER MASK DETAILS

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NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DGG0048A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:6X

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NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

DGG (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

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